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JUL 12 2004
PATENT TRADES MARK

LIST OF ART CITED BY APPLICANT
(PTO-1449)

ATTY. DOCKET NO. 87324.1740	SERIAL NO. 10/622,775
APPLICANT Deepak SAHA, et al.	
FILING DATE July 21, 2003	GROUP 1725

U.S. PATENT DOCUMENTS

EXAMINER'S INITIALS	PATENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE
A	5,935,295	8/10/99	Megy	75	680	6/3/98
B	5,100,618	3/31/92	Dewing et al.	420	528	5/1/90
C						
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FOREIGN PATENT DOCUMENTS

EXAMINER'S INITIALS	PATENT NO.	DATE	COUNTRY	CLASS	SUBCLASS	Translation
U						
V						
W						
X						
Y						
Z						
AA						
BB						
CC						
DD						
EE						
FF						
GG						

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

HH	KB Alloys, Aluminum Grain Refiners, 4/28/03, pg. 1
II	KB Alloys, TIBOR Titanium Boron Aluminum 6/11/03, pg. 1
JJ	Aluminum Fact Sheet, In-Situ Grain Refinement Process for Aluminum, April 2001
KK	Geoffrey K. Sigworth, Role of Alloy Composition in Grain Refining, pgs. 1-9
LL	
MM	
NN	

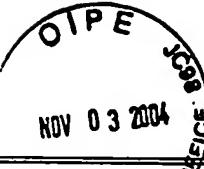
EXAMINER *eww* DATE CONSIDERED *1/17/05*

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.

Docket No.: 87324.1740

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PATENT



LIST OF ART CITED BY APPLICANT
(PTO-1449)

ATTY. DOCKET NO. 87324.1740	SERIAL NO. 10/622,775
APPLICANT Dayne Killingsworth, et al.	
FILING DATE 07/21/03	GROUP

U. S. PATENT DOCUMENTS

EXAMINER'S INITIALS	PATENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE
A	5,846,350	12/08/98	S. Craig Bergsma	148	549	05/01/96
B						

FOREIGN PATENT DOCUMENTS

EXAMINER'S INITIALS	PATENT NO.	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION
C	0 554 808	08/1993	EP			
D						

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HH	✓	G. WAN, et al., "Thixoforming Of Aluminum Alloys Using Modified Chemical Grain Refinement For Billet Product" Associazione Italiana Di Metallurgia, Paizzale Rudolfo Morandi, 2, Milano, Italy 1993. Conference: International Conference On Aluminium Alloys: New Process Technologies, Marina Di Ravenna, Italy, 3-4 June 1993, 129-141 XP009037979
E	✓	Rachmat, R.S., et al., "Application of Semi-solid forming to 2024 and 7075 Wrought Aluminum Billets Fabricated by The EMC Process" Material Schience Forum 329-330, 487-492, Photomicrographs, Graphs, Numerical Data 7 Ref. Switzerland Conference: Solidification and gravity 2000, Miskolc, Hungary, 25-28 April 1999 ISSN: 0255-5476, 2000 XP009037970
F	✓	Zhang, X.-D. (Reynolds Metals) et al.: "Development of Non-Dendritic Microstructures In AA6061 Cast Billets." Materials Science Forum 331-337, (1), 247-252, Graphs, Photomicrographs, 11 ref. Switzerland Conference: Aluminium Alloys: Their Physical and Mechanical Properties(ICaa7), Charlottesville, Virginia, USA 9-14 April 2000 ISSN: 0255-5476, 2000, XP009037968
G	✓	Tahara, K., et al.: "Semi - Solid Solidification Structure in Grain - refined A17%Si-3%Cu Alloy." Aluminium Alloys: Their Physical And Mechanical Properties, 303-308, Photomicrographs, Graphs, 8 Ref. Japan Institute of Light Metals. Tsukamoto Sozan Bldg., 6F, 4-2-15 Ginza, Chuo-Ku, Tokyo, 104-0061, Japan Conference: ICAA-6: 6th International Co, 1998, XP009037987

EXAMINER	DATE CONSIDERED
<i>✓</i>	1/17/05

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.